捷多邦,专业PCB打样工厂,24小时加急出货

August 2008 UniFET™

FAIRCHILD

SEMICONDUCTOR®

FDA24N50 N-Channel MOSFET 500V, 24A, 0.19Ω

Features

WWW.DZSC.COM R_{DS(on)} = 0.16Ω (Typ.)@ V_{GS} = 10V, I_D = 12A

WWW.DZSC

- Low gate charge (Typ. 65nC)
- Low C_{rss} (Typ. 35pF)
- · Fast switching
- 100% avalanche tested
- Improved dv/dt capability
- · RoHS compliant



Description

These N-Channel enhancement mode power field effect transistors are produced using Fairchild's proprietary, planar stripe, DMOS technology.

This advance technology has been especially tailored to minimize on-state resistance, provide superior switching performance, and withstand high energy pulse in the avalanche and commutation mode. These devices are well suited for high efficient switching mode power supplies and active power factor correction.

> D DZSC.CON

TO-3PN

GDS

MOSFET Maximum Ratings T_C = 25°C unless otherwise noted

Symbol		Parameter		Ratings	Units
V _{DSS}	Drain to Source Voltage	C. COM		500	V
V _{GSS}	Gate to Source Voltage	.0750		±30	V
	Desire Current	-Continuous (T _C = 25 ^o C)		24	
I _D	Drain Current	-Continuous (T _C = 100 ^o C)		14	Α
IDM	Drain Current	- Pulsed	- Pulsed (Note 1)		A
E _{AS}	Single Pulsed Avalanche Energy (Note		(Note 2)	1872	mJ
I _{AR}	Avalanche Current		(Note 1)	24	A
E _{AR}	Repetitive Avalanche Energy		(Note 1)	2.7	mJ
dv/dt	Peak Diode Recovery dv/dt		(Note 3)	4.5	V/ns
P _D	Power Dissipation	$(T_{\rm C} = 25^{\rm o}{\rm C})$		270	W
		- Derate above 25°C		2.2	W/ºC
T _J , T _{STG}	Operating and Storage Temperature Range			-55 to +150	°C
TL	Maximum Lead Temperature for Soldering Purpose, 1/8" from Case for 5 Seconds			300	°C

Thermal Characteristics

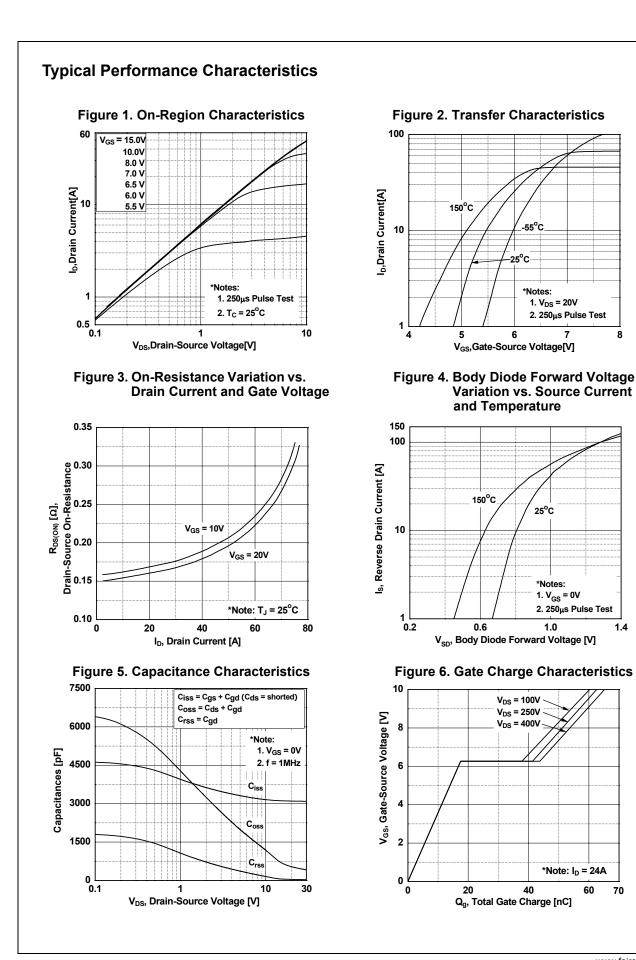
Symbol	Parameter	Ratings	Units
$R_{\theta JC}$	Thermal Resistance, Junction to Case	0.46	
$R_{\theta CS}$	Thermal Resistance, Case to Sink Typ.	0.24	°C/W
Rejanc	Thermal Resistance, Junction to Ambient	40	

1

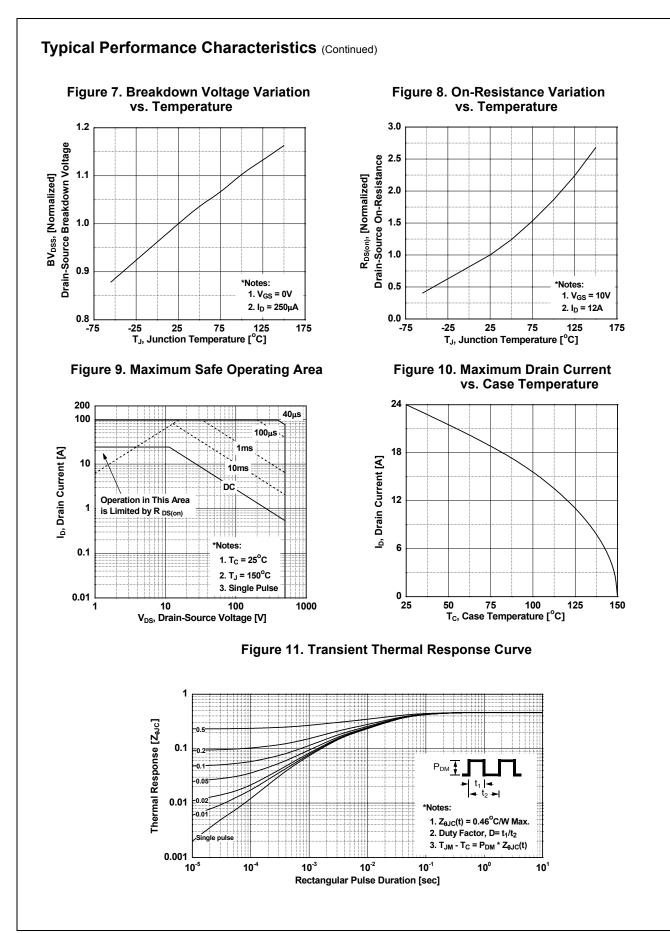
Device Marking Device F		Package	Reel Size	Таре	e Width		Quantit	у	
		TO-3PN	-		-		30		
Electrica	l Chara	acteristics T _C =	25°C unless othe	erwise noted					
Symbol	Parameter			Test Conditions		Min.	Тур.	Max.	Units
Off Charac	teristics	5							
BV _{DSS}	Drain to	ain to Source Breakdown Voltage		I _D = 250μA, V _{GS} = 0V, T _J = 25 ^o C		500	-	-	V
$\frac{\Delta BV_{DSS}}{\Delta T_J}$	Breakdown Voltage Temperature Coefficient		Iro	$I_D = 250 \mu A$, Referenced to $25^{\circ}C$		-	0.66	-	V/ºC
	Zero Ga	Zero Gate Voltage Drain Current		$V_{DS} = 500V, V_{GS} = 0V$ $V_{DS} = 400V, T_C = 125^{\circ}C$		-	-	1	μA
DSS	2010 00					-	-	10	μΛ
I _{GSS}	Gate to	Gate to Body Leakage Current		_{GS} = ±30V, V _{DS} = 0V		-	-	±100	nA
On Charac	teristics	5							
V _{GS(th)}	Gate Th	reshold Voltage	V	V _{GS} = V _{DS} , I _D = 250μA		3.0	-	5.0	V
R _{DS(on)}		ain to Source On Res		_{GS} = 10V, I _D = 12A		-	0.16	0.19	Ω
9FS	Forward	Transconductance		$V_{\rm DS} = 20V, I_{\rm D} = 12A$ (Note 4)			28	-	S
Dynamic (haracte	ristics	i						
	Characteristics Input Capacitance				-	3120	4150	pF	
C _{oss}		Capacitance	V	V _{DS} = 25V, V _{GS} = 0V f = 1MHz		-	460	615	pF
		Transfer Capacitance				_	35	52	pF
C _{rss}		te Charge at 10V	,			-	65	85	nC
Q _{g(tot)} Q _{gs}		Source Gate Charge	v	V _{DS} = 400V, I _D = 24A V _{GS} = 10V		-	18	-	nC
Q _{gd}		Drain "Miller" Charge				-	26	_	nC
					(Note 4, 5)		20		110
Switching	1								1
t _{d(on)}		Delay Time			-	47	104	ns	
t _r		Rise Time		V_{DD} = 250V, I _D = 24A R _G = 25Ω (Note 4, 5)		-	108	226	ns
t _{d(off)}		Delay Time	N			-	164	338	ns
t _f	Turn-Off	Fall Time				-	86	182	ns
Drain-Sou	rce Diod	e Characteristic	S						
ls	Maximum Continuous Drain to Source Diode Forward Current					-	-	24	А
I _{SM}	Maximum Pulsed Drain to Source Diode F		rce Diode Forwa			-	-	96	Α
V _{SD}	Drain to	Source Diode Forward	d Voltage V ₀	_{GS} = 0V, I _{SD} = 24A		-	-	1.4	V
t _{rr}	Reverse	Recovery Time		V _{GS} = 0V, I _{SD} = 24A		-	540	-	ns
Q _{rr}	Reverse	Recovery Charge	dl	_F /dt = 100A/µs	(Note 4)	-	8.1	-	μC
2. L = 6.5mH, I _{AS} 3. I _{SD} ≤ 24A, di/dt 4. Pulse Test: Puls	= 24A, V _{DD} = ξ ≤ 200A/μs, V _D se width ≤ 300μ	limited by maximum junction 50V, R _G = 25 Ω , Starting T _J = 25 Ω _D \leq BV _{DSS} , Starting T _J = 25 Ω _{Is} , Duty Cycle \leq 2% erating Temperature Typical	25°C C						

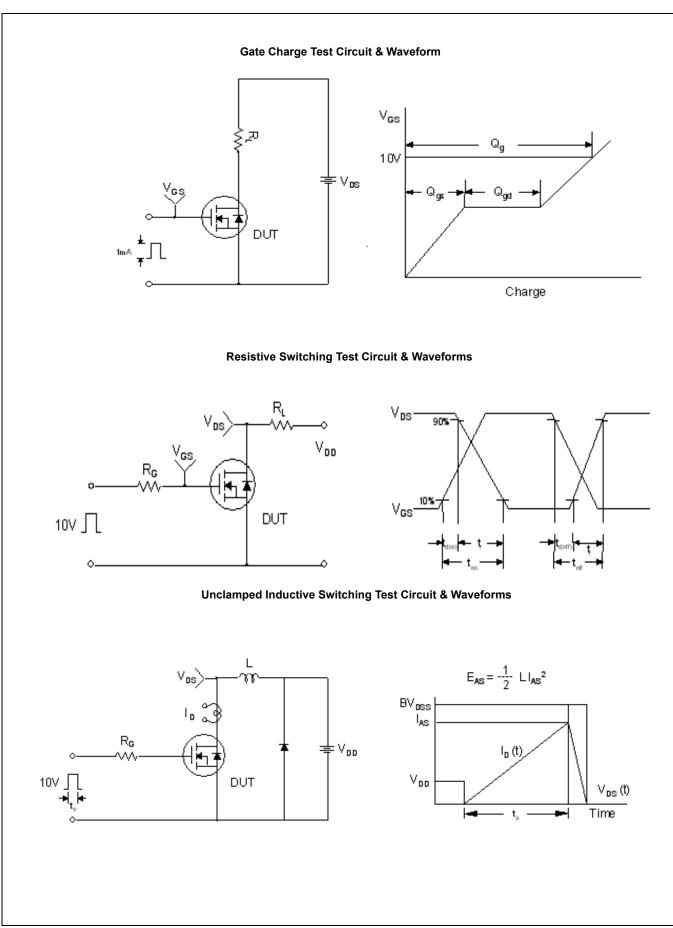
8

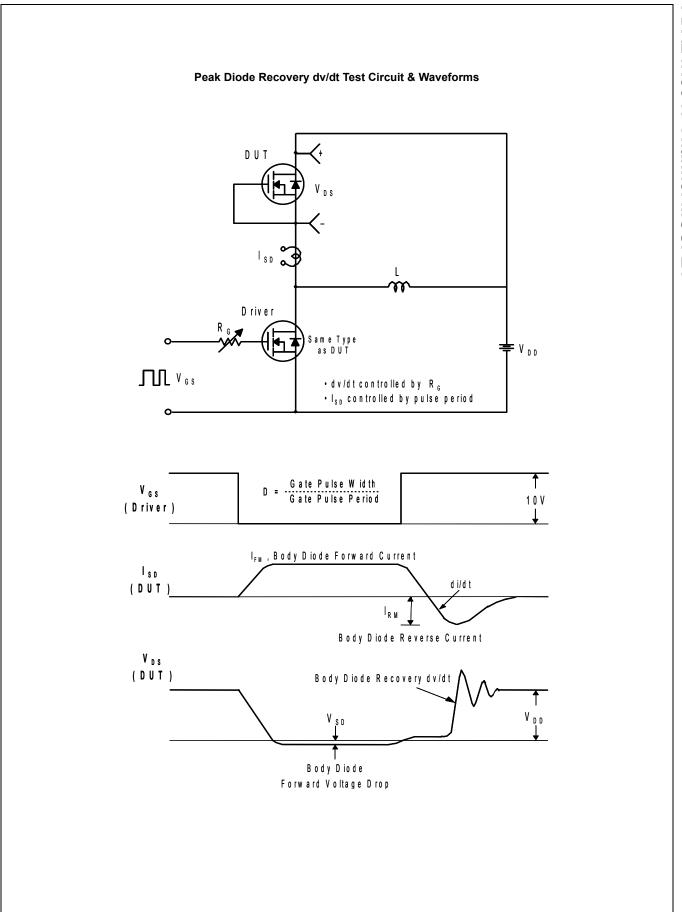
1.4

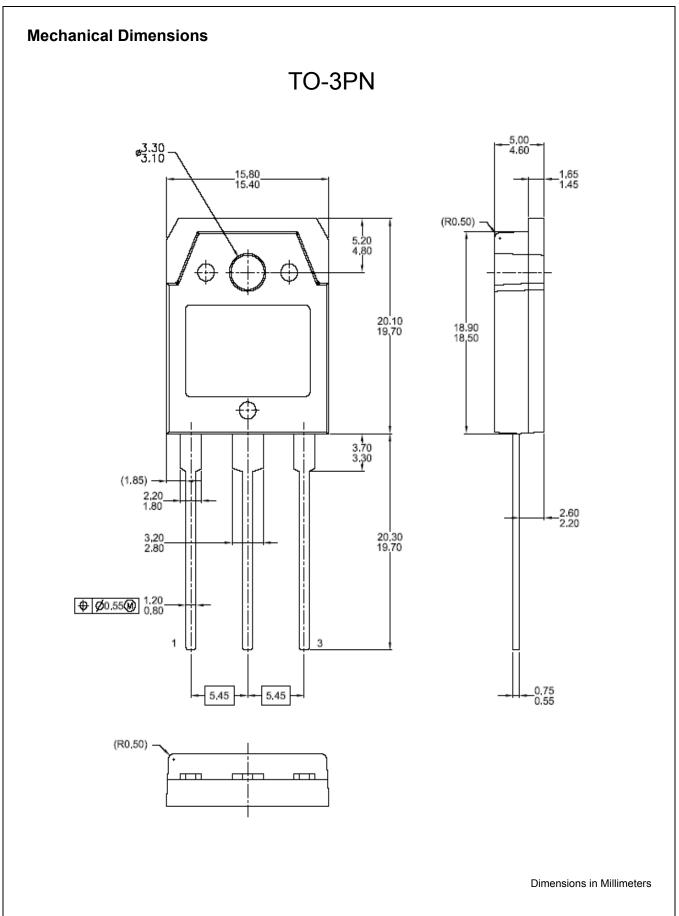


70











SEMICONDUCTOR

TRADEMARKS

The following includes registered and unregistered trademarks and service marks, owned by Fairchild Semiconductor and/or its global subsidianries, and is not intended to be an exhaustive list of all such trademarks.

Build it Now™	FPS™	PDP SPM™	The Power Franchise [®]
CorePLUS™	F-PFS™	Power-SPM™	the
CorePOWER™	FRFET®	PowerTrench [®]	puwer
ROSSVOLT™	Global Power Resource SM	Programmable Active Droop™	franchise
TL™	Green FPS™	QFET®	TinyBoost™ Tin Book ™
urrent Transfer Logic™	Green FPS™ e-Series™	QS™	TinyBuck™
coSPARK [®]	GTO™	Quiet Series™	
ficentMax™	IntelliMAX™	RapidConfigure™	TINYOPTO™
ZSWITCH™ *	ISOPLANAR™	Saving our world, 1mW at a time™	TinyPower™
TM	MegaBuck™	SmartMax™	TinyPWM™
-7	MICROCOUPLER™	SMART START™	TinyWire™
R R	MicroFET™	SPM®	\mathcal{M}
-	MicroPak™	STEALTH™	Ser Des"
airchild [®]	MillerDrive™	SuperFET™	UHC®
airchild Semiconductor®	MotionMax™	SuperSOT™-3	Ultra FRFET™
ACT Quiet Series™	Motion-SPM™	SuperSOT™-6	UniFET™
ACT [®]	OPTOLOGIC®	SuperSOT™-8	VCX TM
∖ST [®]	OPTOPLANAR®	SupreMOS™	VisualMax™
astvCore™	®	SyncFET™	
ashWriter [®] *		,	
ZSWITCH™ and ElashWriter [®] are	trademarks of System General Corporat	ion, used under license by Fairchild Semic	anductor

DISCLAIMER

DISCLAIMER FAIRCHILD SEMICONDUCTOR RESERVES THE RIGHT TO MAKE CHANGES WITHOUT FURTHER NOTICE TO ANY PRODUCTS HEREIN TO IMPROVE RELIABILITY, FUNCTION, OR DESIGN. FAIRCHILD DOES NOT ASSUME ANY LIABILITY ARISING OUT OF THE APPLICATION OR USE OF ANY PRODUCT OR CIRCUIT DESCRIBED HEREIN; NEITHER DOES IT CONVEY ANY LICENSE UNDER ITS PATENT RIGHTS, NOR THE RIGHTS OF OTHERS. THESE SPECIFICATIONS DO NOT EXPAND THE TERMS OF FAIRCHILD'S WORLDWIDE TERMS AND CONDITIONS, SPECIFICALLY THE WARRANTY THEREIN, WHICH COVERS THESE PRODUCTS.

LIFE SUPPORT POLICY

FAIRCHILD'S PRODUCTS ARE NOT AUTHORIZED FOR USE AS CRITICAL COMPONENTS IN LIFE SUPPORT DEVICES OR SYSTEMS WITHOUT THE EXPRESS WRITTEN APPROVAL OF FAIRCHILD SEMICONDUCTOR CORPORATION.

As used herein:

- Life support devices or systems are devices or systems which, (a) are 1. intended for surgical implant into the body or (b) support or sustain life, and (c) whose failure to perform when properly used in accordance with instructions for use provided in the labeling, can be reasonably expected to result in a significant injury of the user.
- A critical component in any component of a life support, device, or 2. system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.

ANTI-COUNTERFEITING POLICY

Fairchild Semiconductor Corporation's Anti-Counterfeiting Policy. Farichild's Anti-Counterfeiting Policy is also stated on our external website, www.fairchildsemi.com, under Sales Support.

Counterfeiting of semiconductor parts is a growing problem in the industry. All manufactures of semiconductor products are experiencing counterfeiting of their parts. Customers who inadvertently purchase counterfeit parts experience many problems such as loss of brand reputation, substandard performance, failed application, and increased cost of production and manufacturing delays. Fairchild is taking strong measures to protect ourselves and our customers from the proliferation of counterfeit parts. Farichild strongly encourages customers to purchase Farichild parts either directly from Fairchild or from Authorized Fairchild Distributors who are listed by country on our web page cited above. Products customers buy either from fairchild directly or from Authorized Fairchild Distributors are genuine parts, have full traceability, meet Fairchild's quality standards for handing and storage and provide access to Farichild's full range of up-to-date technical and product information. Fairchild and our Authorized Distributors will stand behind all warranties and will appropriately address and warranty issues that may arise. Fairchild will not provide any warranty coverage or other assistance for parts bought from Unauthorized Sources. Fairchild is committed to committed to combat this global problem and encourage our customers to do their part in stopping this practice by buying direct or from authorized distributors.

PRODUCT STATUS DEFINITIONS Definition of Terms

Product Status	Definition
Formative / In Design	Datasheet contains the design specifications for product development. Specifications may change in any manner without notice.
First Production	Datasheet contains preliminary data; supplementary data will be published at a later date. Fairchild Semiconductor reserves the right to make changes at any time without notice to improve design.
Full Production	Datasheet contains final specifications. Fairchild Semiconductor reserves the right to make changes at any time without notice to improve the design.
Not In Production	Datasheet contains specifications on a product that is discontinued by Fairchild Semiconductor. The datasheet is for reference information only.
	Formative / In Design First Production Full Production